

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Adria Bofill-Petit</td> <td>06/16/2008</td> </tr> <tr> <td>Robert K. Henderson</td> <td>06/16/2008</td> </tr> <tr> <td>Jonathan Ephriam David Hurwitz</td> <td>06/13/2008</td> </tr> </tbody> </table>		Name	Execution Date	Adria Bofill-Petit	06/16/2008	Robert K. Henderson	06/16/2008	Jonathan Ephriam David Hurwitz	06/13/2008
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Adria Bofill-Petit	06/16/2008								
Robert K. Henderson	06/16/2008								
Jonathan Ephriam David Hurwitz	06/13/2008								
RECEIVING PARTY DATA									
Name:	Gigle Semiconductor Ltd.								
Street Address:	10 South St. Andrews Street								
City:	Edinburgh								
State/Country:	UNITED KINGDOM								
Postal Code:	EH2 2AZ								
PROPERTY NUMBERS Total: 1									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12145475</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12145475				
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Application Number:	12145475								
CORRESPONDENCE DATA									
Fax Number:	(650)324-1678								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone:	650-324-1677								
Email:	scolby@petersverny.com								
Correspondent Name:	PETERS VERNY , L.L.P.								
Address Line 1:	425 SHERMAN AVENUE								
Address Line 2:	SUITE 230								
Address Line 4:	PALO ALTO, CALIFORNIA 94306								
ATTORNEY DOCKET NUMBER:	5368.02 (SMC)								
NAME OF SUBMITTER:	Steven M. Colby								

Total Attachments: 6
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PATENT
REEL: 021145 FRAME: 0203

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ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned, **Adrià Bofill-Petit, Robert K. Henderson and Jonathan Ephriam David Hurwitz**, do hereby sell, assign, and transfer to **Gigle Semiconductor Ltd., 10 South St Andrews Street, Edinburgh, EH2 2AZ United Kingdom** ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the United States patent application filed on even date herewith and titled:

"Resistor-Input Transconductor Including Common-mode Compensation"

and in and to said application and all utility, divisional, continuing, substitute, renewal, reissue, and all other patent applications which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States patent application; and

Agree that said Assignee may apply for and receive patents for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and

the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: _____

Name: _____
Adrià Bofill-Petit

Date: 16-6-08

Name: Robert K. Henderson
Robert K. Henderson

Date: _____

Name: _____
Jonathan Ephriam David Hurwitz

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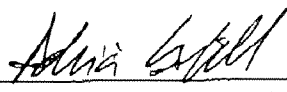
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Date: JUNE -16 - 2008

Name: 
Adrià Bofill-Petit

Date: _____

Name: _____
Robert K. Henderson

Date: _____

Name: _____
Jonathan Ephriam David Hurwitz

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Date: _____

Name: _____

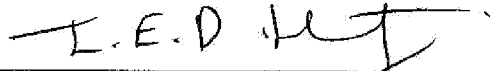
Adrià Bofill-Petit

Date: _____

Name: _____

Robert K. Henderson

Date: 13th June 2008

Name: 

Jonathan Ephriam David Hurwitz